MP2735/MP2736

Low-Voltage 0.45Ω Dual SPDT Analog Switches

MP2735 NOT RECOMMENDED FOR NEW DESIGNS. REFER TO MP2736

GENERAL DESCRIPTION

The MP2735/MP2736 are low voltage, low on-resistance, dual single-pole, double-throw (SPDT) monolithic CMOS analog switches designed for high performance switching of analog signals. Combining low-power, high speed, low on-resistance, and small package size, the MP2735/MP2736 are ideal for portable and battery power applications.

The MP2735/MP2736 have an operation range from 1.65V to 5.5V single supply. The MP2735 has two separate control pins and two separate SPDT switches. The MP2736 includes an $\overline{\text{EN}}$ pin. All switches are at high impedance mode when the $\overline{\text{EN}}$ is high.

The MP2735/MP2736 are guaranteed 1.65V logic compatible for V+<3.3V, allowing the easy interface with low voltage DSP or MCU control logic and ideal for one cell Li-ion battery direct power.

The switch conducts signals within power rails equally well in both directions when on, and blocks up to the power supply level when off. Break-before-make is guaranteed.

The MP2735/MP2736 are offered in a QFN10 package.

FEATURES

- Low Voltage Operation (1.65V to 5.5V)
- Low On-Resistance R_{ON}: 0.45Ω at 2.7V
- Fast Switching: T_{ON} = 29ns at 2.7V
- $T_{OFF} = 23$ ns at 2.7V
- Latch-Up Current >300mA (JESD78)
- 1.4mm x 1.8mm QFN10 Package
- ESD Human-Body Model ±4000V

APPLICATIONS

- Cellular Phones
- Speaker Headset Switching
- Audio and Video Signal Routing
- PCMCIA Cards
- Battery Powered Systems
- Portable Media Player
- Handheld Test Instruments

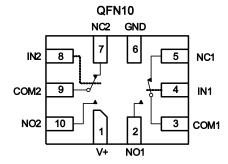
TRUTH TABLE

	IN1/2	ĒΝ	NC1/2	NO1/2
MP2735	0	1	ON	OFF
WP2735	1	1	OFF	ON
	0	1	OFF	OFF
MP2736	1	1	OFF	OFF
IVIP2/30	0	0	ON	OFF
	1	0	OFF	ON

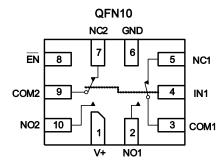
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FUNCTIONAL BLOCK DIAGRAM PIN CONFIGURATION

MP2735DQG



MP2736DQG



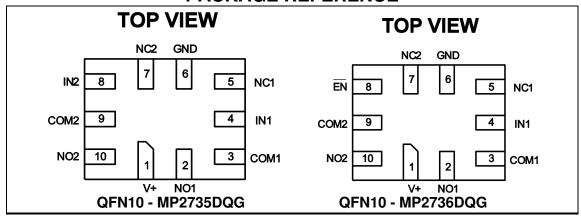


ORDERING INFORMATION

Part Number*	Package	Top Marking	Free Air Temperature (T _A)
MP2735DQG	QFN10	2T	4000 1 0500
MP2736DQG	(1.4mm x1.8mm)	ĀM	-40°C to +85°C

* For Tape & Reel, add suffix –Z (e.g. MP2735DQG–Z). For RoHS compliant packaging, add suffix –LF (e.g. MP2735DQG–LF–Z)

PACKAGE REFERENCE



ABSOLUTE MAXIMUM RATINGS

V+ Supply Voltage0.3V to +6V IN/COM/NC/NO Voltage $^{(1)}$ 0.3V to V+ + 0.3V Current
(Any terminal except NO, NC or COM)
•
30mA
Continuous Current (NO, NC or COM)
±250mA
Peak Current
(Pulsed at 1ms, 10% duty cycle)±500mA
Storage Temperature65°C to +150°C
Power Dissipation (QFN10 (2)) (3)208mW

Notes:

- Signals on NC, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- 2) Derate 4.0mW/°C above 70°C.
- 3) All leads welded or soldered to PC Board.



ELECTRICAL CHARACTERISTICS

V+=3V, $\pm 10\%$, $V_{IN}=0.4$ or 1.65V, unless otherwise noted.

Parameter	Symbol	Condition			Тур	Max	Units
Analog Switch							
Analog Signal Range	Vanalog	r _{DS(on)} , T _A = -40°C to +85°C		0		V+	V
		V+=2.7V, I _{NO/NC} =100mA, V _{COM} =0.5V V+=2.7V, I _{NO/NC} =100mA, V _{COM} =1.5V	T _A = +25°C		0.28	0.45	
On-		V+=2.7V, I _{NO/NC} =100mA, V _{COM} =0.5V V+=2.7V, I _{NO/NC} =100mA, V _{COM} =1.5V	T _A = -40°C to +85°C		0.30		
Resistance	r _{DS(on)}	V+=5.5V, I _{NO/NC} =100mA, V _{COM} =0.9V	T .0500		0.20	0.20	
		V+=5.5V, I _{NO/NC} =100mA, V _{COM} =2.5V	T _A = +25°C		0.18	0.30	
		V+=5.5V, I _{NO/NC} =100mA, V _{COM} =0.9V	T _A = -40°C		0.25		Ω
		V+=5.5V, I _{NO/NC} =100mA, V _{COM} =2.5V	to +85°C		0.20		
ray Motob	Δr _{on}	V+=2.7V, I _{NO/NC} =100mA, V _{COM} =0.5V/1.5V			0.01	0.02	
ron Match		V+=5.5V, I _{NO/NC} =100mA, V _{COM} =0.9V/2.5V	T _A = +25°C				
ron Flatness	r _{ON} Flatness	V+=2.7V, I _{NO/NC} =100mA, V _{COM} =0.5V/1.5V					
	INO/NC(off)	$\begin{array}{c} T_{A} = +25^{\circ}C \\ T_{A} = -40^{\circ}C \\ to +85^{\circ}C \\ T_{A} = -40^{\circ}C \\ to +85^{\circ}C \\ T_{A} = +25^{\circ}C \\ T_{A} = -40^{\circ}C \\ to +85^{\circ}C \\ \end{array}$	T _A = +25°C	-40		40	
Switch Off				-100		100	
Leakage Current	I _{COM(off)}		-40		40	-	
				-100		100	nA
Channel-On		T _A = +25°C	T _A = +25°C	-40		40	
Leakage I _{COM(on)} Current		$V+=5.5V$, $V_{NO/NC}=V_{COM}=4.0V/0.3V$ $T_{A}=-40^{\circ}C$ to $+85^{\circ}C$		-150		150	
Digital Control							
Input High Voltage	Vinh			1.65			.,
Input Low Voltage	V _{INL}		T _A = -40°C to +85°C			0.4	V
Input Capacitance	Cin				6		pF
Input Current	I _{INL} or I _{INH}	V _{IN} =0 or V+		-1		1	μΑ



ELECTRICAL CHARACTERISTICS (continued)

V+=3V, $\pm 10\%$, $V_{IN}=0.4$ or 1.65V, unless otherwise noted.

Parameter	Symbol	Condition			Тур	Max	Units
Dynamic Characteristics							
Break-Before- Make Time	tввм		T _{A=} +25°C		10		ns
	ton				24	36	
Turn-On Time			T _A = -40°C to +85°C			40	
			T _A = +25°C		20	30	
Turn-Off Time	toff	V+=3.6V, V _{NO} /V _{NC} =1.5V, R _L =50Ω, C _L =35pF	T _A = -40°C to +85°C			35	
Enable Turn-On			T _A = +25°C		24	36	
Time MP2736 (\overline{EN})	ton(EN)		T _A = -40°C to +85°C			40	
Enable Turn-Off			T _A = +25°C		20	30	
Time MP2736 (\overline{EN})	toff(EN)		T _A = -40°C to +85°C			35	
Off-Isolation(4)	OIRR	D 500 0 5 5 (400)			-70		dB
Crosstalk(4)	XTALK	R _L =50 Ω , C _L =5pF, f=100kHz			-70		dB
3dB Bandwidth		R _L =50Ω, C _L =5pF			50		MHz
NO, NC Off	C _{NO(off)}		T _A = +25°C		55		pF
Capacitance ⁽⁴⁾ Channel On Capacitance ⁽⁴⁾	C _{NC(off)}	\\			55		
	C _{NO(on)}	V _{IN} =0V, or V+, f=1MHz			130		
	C _{NC(on)}				130		
Power Supply							
Power Supply Range	V+			1.65		5.5	V
Power Supply Current	l+	V _{IN} =0 or V+	T _A = -40°C to +85°C	-1		1	μA

Note:

Guarantee by design, not subjected to production test.



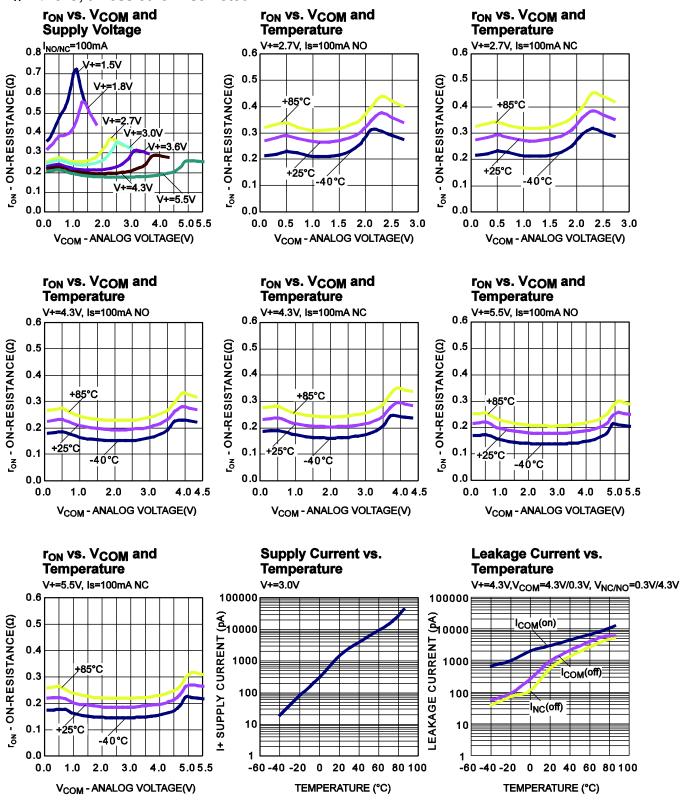
PIN FUNCTIONS

(MP2735DQG) Pin #	(MP2736DQG) Pin #	Name	Description
1	1	V+	Supply Voltage
2	2	NO1	Normally open I/O port of switch1
3	3	COM1	Commom I/O port for NC and NO channels of switch1
4	4	IN1	Channel select signal for switch1. IN1 high, NO1 channel is selected. Otherwise, NC1 channel is selected in default. For MP2736, IN1 controls both switch1 and switch2
5	5	NC1	Normally closed I/O port of switch1
6	6	GND	Ground
7	7	NC2	Normally closed I/O port of switch2
8		IN2	Channel select signal for switch2. IN2 high, NO2 channel is selected. Otherwise, NC2 channel is selected in default
	8	ĒΝ	Enable for two channels, active low
9	9	COM2	Commom I/O port for NC and NO channels of switch2
10	10	NO2	Normally open I/O port of switch2



TYPICAL PERFORMANCE CHARACTERISTICS

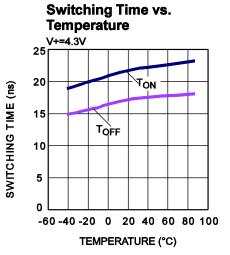
 $T_A = +25$ °C, unless otherwise noted.

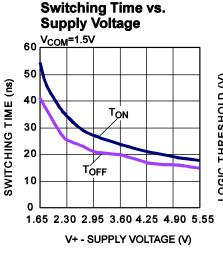


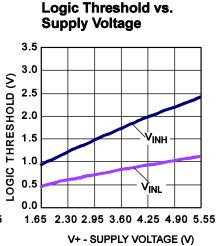


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

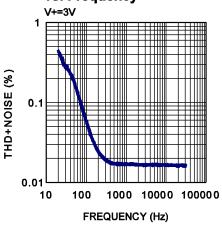
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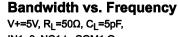


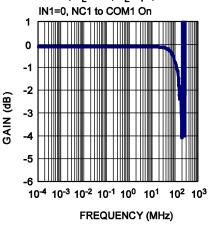




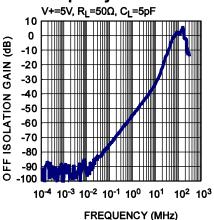
Total Harmonic Distortion vs. Frequency





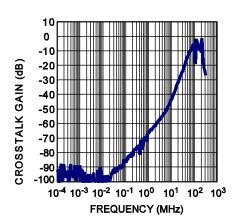


Off Isolation vs. Frequency

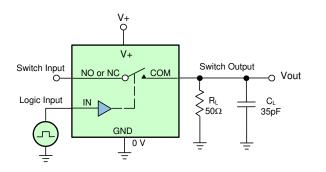


Crosstalk vs. Frequency

V+=5V, R_L=50Ω, C_L=5pF

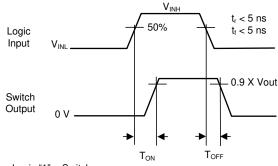


TEST CIRCUITS



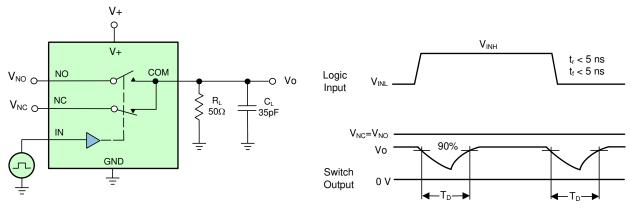
C_L (includes fixture and stray capacitance)

$$V_{\text{out}} = V_{\text{COM}}(\frac{R_{\text{L}}}{R_{\text{L}} + R_{\text{ON}}})$$



Logic "1" = Switch on Logic input waveforms inverted for switches that have the opposite logic sense.

Figure 1 — Switching Time



C_L (includes fixture and stray capacitance)

Figure 2 — Break-Before-Make Interval

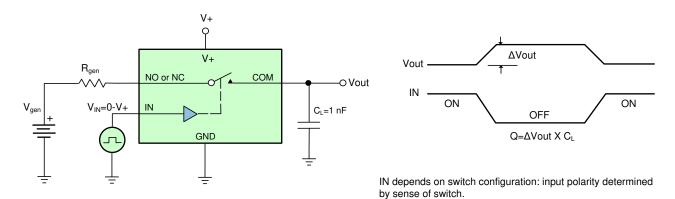


Figure 3 — Charge Injection

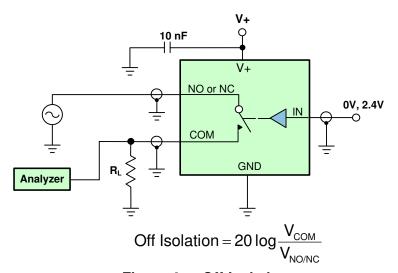


Figure 4 — Off-Isolation

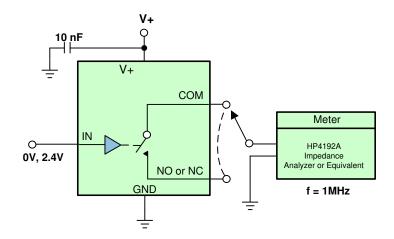
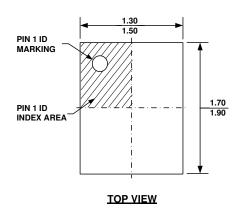


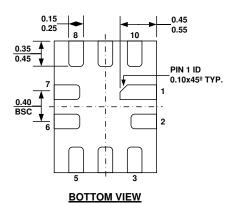
Figure 5 — Channel Off/On Capacitance

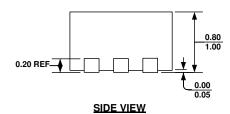


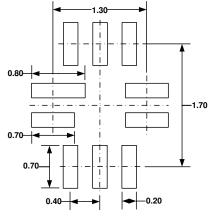
PACKAGE INFORMATION

PACKAGE OUTLINE DRAWING FOR 10L FCQFN (1.4x1.8mm) MF-PO-D-0084 revision 0.0









NOTE:

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
- 3) LEAD COPLANARITY SHALL BE 0.10 MILLIMETER MAX.
- 4) JEDEC REFERENCE IS MO-220. 5) DRAWING IS NOT TO SCALE.

RECOMMENDED LAND PATTERN

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